



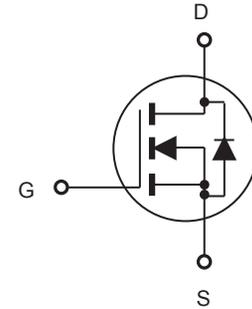
# CEP6056/CEB6056

## N-Channel Enhancement Mode Field Effect Transistor

PRELIMINARY

### FEATURES

- 60V, 100A,  $R_{DS(ON)} = 6.2m\Omega$  @  $V_{GS} = 10V$ .
- Super high dense cell design for extremely low  $R_{DS(ON)}$ .
- High power and current handling capability.
- Lead free product is acquired.
- TO-220 & TO-263 package.



### ABSOLUTE MAXIMUM RATINGS $T_C = 25^\circ C$ unless otherwise noted

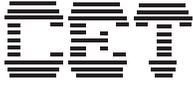
| Parameter   | Symbol         | Limit      | Units         |
|---|----------------|------------|---------------|
| Drain-Source Voltage  | $V_{DS}$       | 60         | V             |
| Gate-Source Voltage   | $V_{GS}$       | $\pm 20$   | V             |
| Drain Current-Continuous  | $I_D$          | 100        | A             |
| Drain Current-Pulsed <sup>a</sup>   | $I_{DM}$       | 360        | A             |
| Maximum Power Dissipation @ $T_C = 25^\circ C$<br>- Derate above $25^\circ C$ | $P_D$          | 100        | W             |
|   |                | 0.66       | W/ $^\circ C$ |
| Single Pulsed Avalanche Energy <sup>d</sup>                                   | $E_{AS}$       | 160        | mJ            |
| Single Pulsed Avalanche Current <sup>d</sup>                                  | $I_{AS}$       | 80         | A             |
| Operating and Store Temperature Range   | $T_J, T_{stg}$ | -55 to 175 | $^\circ C$    |

### Thermal Characteristics

| Parameter                               | Symbol          | Limit | Units        |
|---|-----------------|-------|--------------|
| Thermal Resistance, Junction-to-Case    | $R_{\theta JC}$ | 1.5   | $^\circ C/W$ |
| Thermal Resistance, Junction-to-Ambient | $R_{\theta JA}$ | 62.5  | $^\circ C/W$ |

This is preliminary information on a new product in development now .  
Details are subject to change without notice .

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<http://www.cetsemi.com>



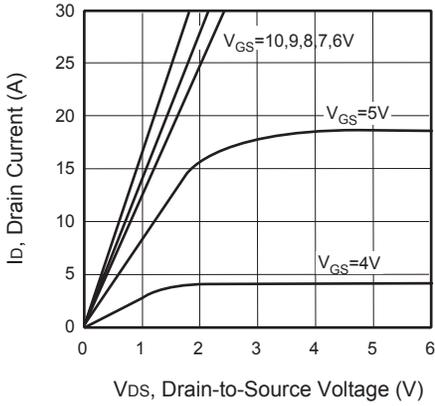
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## Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted

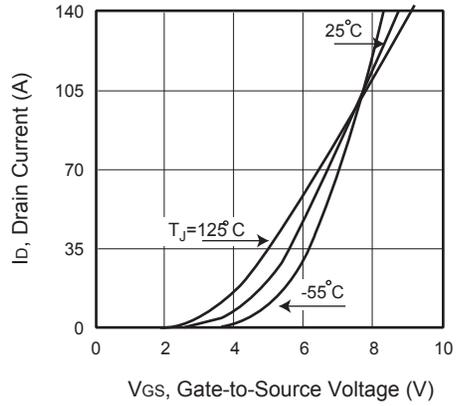
| Parameter   | Symbol       | Test Condition  | Min | Typ  | Max  | Units      |
|---|--------------|---|-----|------|------|------------|
| <b>Off Characteristics</b>  |              |   |     |      |      |            |
| Drain-Source Breakdown Voltage  | $BV_{DSS}$   | $V_{GS} = 0V, I_D = 250\mu A$                                     | 60  |      |      | V          |
| Zero Gate Voltage Drain Current   | $I_{DSS}$    | $V_{DS} = 60V, V_{GS} = 0V$                                       |     |      | 1    | $\mu A$    |
| Gate Body Leakage Current, Forward  | $I_{GSSF}$   | $V_{GS} = 20V, V_{DS} = 0V$                                       |     |      | 100  | nA         |
| Gate Body Leakage Current, Reverse  | $I_{GSSR}$   | $V_{GS} = -20V, V_{DS} = 0V$                                      |     |      | -100 | nA         |
| <b>On Characteristics<sup>b</sup></b>   |              |   |     |      |      |            |
| Gate Threshold Voltage  | $V_{GS(th)}$ | $V_{GS} = V_{DS}, I_D = 250\mu A$                                 | 2   |      | 4    | V          |
| Static Drain-Source On-Resistance   | $R_{DS(on)}$ | $V_{GS} = 10V, I_D = 20A$   |     | 5    | 6.2  | m $\Omega$ |
| <b>Dynamic Characteristics<sup>c</sup></b>  |              |   |     |      |      |            |
| Forward Transconductance  | $g_{FS}$     | $V_{DS} = 25V, I_D = 50A$   |     | 21   |      | S          |
| Input Capacitance   | $C_{iss}$    | $V_{DS} = 25V, V_{GS} = 0V,$<br>$f = 1.0\text{ MHz}$              |     | 3215 |      | pF         |
| Output Capacitance  | $C_{oss}$    |   |     | 375  |      | pF         |
| Reverse Transfer Capacitance  | $C_{rss}$    |   |     | 215  |      | pF         |
| <b>Switching Characteristics<sup>c</sup></b>  |              |   |     |      |      |            |
| Turn-On Delay Time  | $t_{d(on)}$  | $V_{DD} = 30V, I_D = 50A,$<br>$V_{GS} = 10V, R_{GEN} = 3.6\Omega$ |     | 27   | 54   | ns         |
| Turn-On Rise Time   | $t_r$        |   |     | 15   | 30   | ns         |
| Turn-Off Delay Time   | $t_{d(off)}$ |   |     | 58   | 116  | ns         |
| Turn-Off Fall Time  | $t_f$        |   |     | 15   | 30   | ns         |
| Total Gate Charge   | $Q_g$        | $V_{DS} = 48V, I_D = 50A,$<br>$V_{GS} = 10V$                      |     | 77   | 100  | nC         |
| Gate-Source Charge  | $Q_{gs}$     |   |     | 15   |      | nC         |
| Gate-Drain Charge   | $Q_{gd}$     |   |     | 30   |      | nC         |
| <b>Drain-Source Diode Characteristics and Maximum Ratings</b>   |              |   |     |      |      |            |
| Drain-Source Diode Forward Current  | $I_S$        |   |     |      | 100  | A          |
| Drain-Source Diode Forward Voltage <sup>b</sup>   | $V_{SD}$     | $V_{GS} = 0V, I_S = 50A$  |     |      | 1.3  | V          |
| <b>Notes :</b> □<br>a.Repetitive Rating : Pulse width limited by maximum junction temperature<br>b.Pulse Test : Pulse Width $\leq 300\mu s$ , Duty Cycle $\leq 2\%$ . □<br>c.Guaranteed by design, not subject to production testing. □<br>d.L = 50 $\mu H$ , $I_{AS} = 80A$ , $V_{DD} = 24V$ , $R_G = 25\Omega$ , Starting $T_J = 25\text{ C}$ |              |   |     |      |      |            |



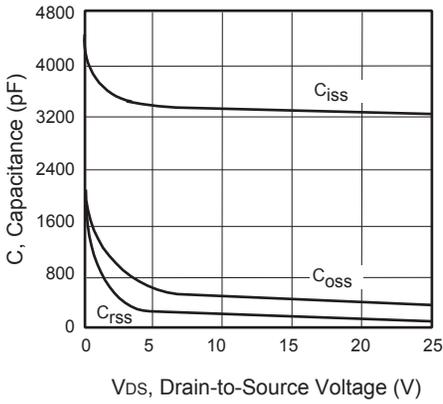
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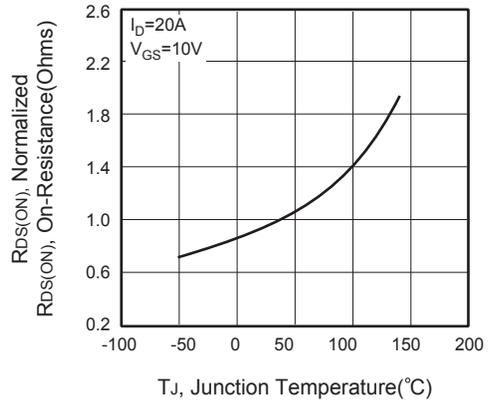
**Figure 1. Output Characteristics**



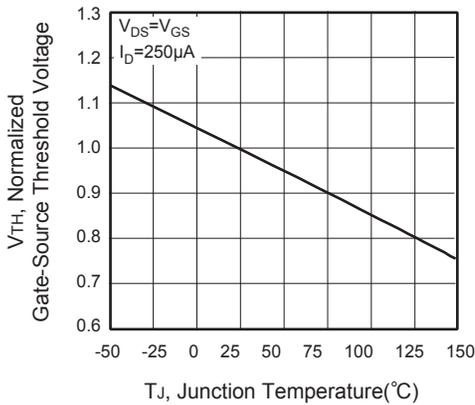
**Figure 2. Transfer Characteristics**



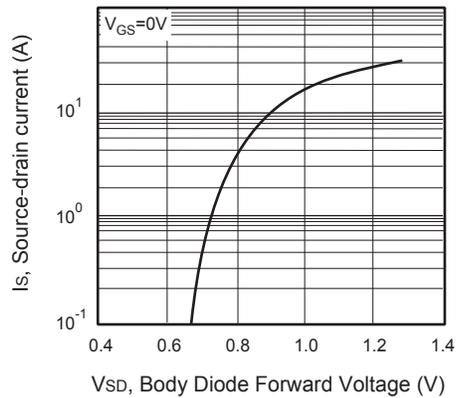
**Figure 3. Capacitance**



**Figure 4. On-Resistance Variation with Temperature**



**Figure 5. Gate Threshold Variation with Temperature**



**Figure 6. Body Diode Forward Voltage Variation with Source Current**



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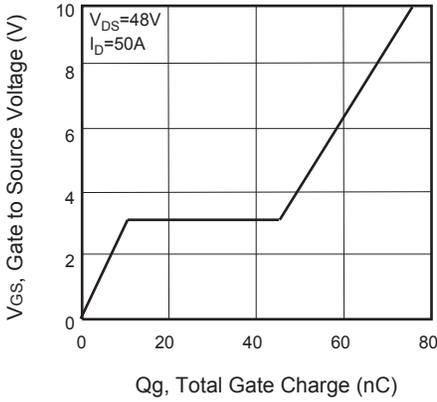


Figure 7. Gate Charge

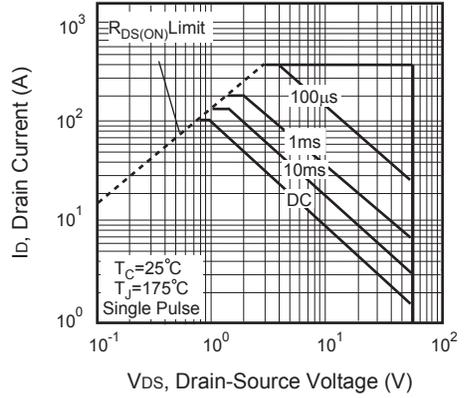


Figure 8. Maximum Safe Operating Area

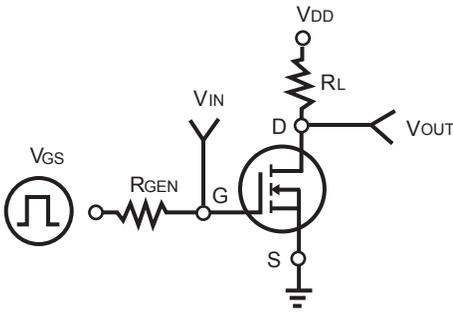


Figure 9. Switching Test Circuit

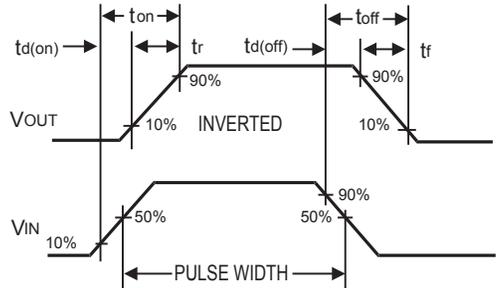


Figure 10. Switching Waveforms

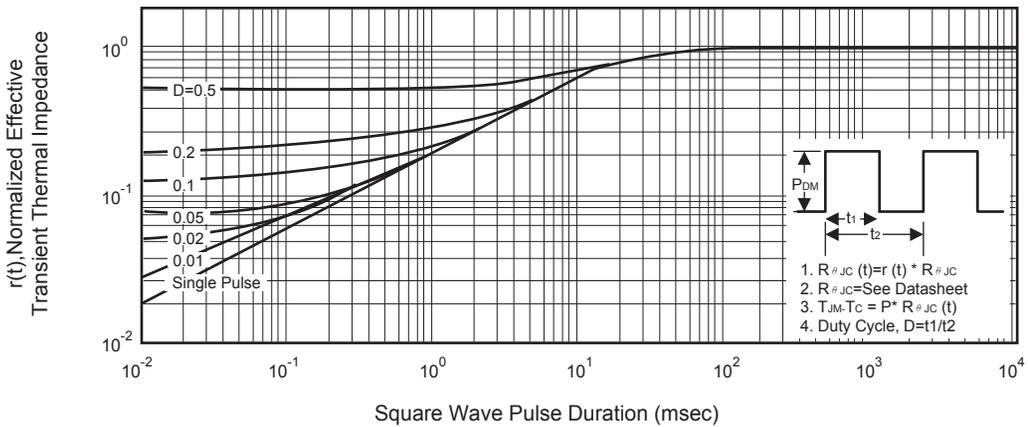


Figure 11. Normalized Thermal Transient Impedance Curve